

# UNITED STATES PATENT AND TRADEMARK OFFICE

UNITED STATES DEPARTMENT OF COMMERCE United States Patent and Trademark Office Address: COMMISSIONER FOR PATENTS P.O. Box 1450 Alexandria, Virginia 22313-1450 www.uspto.gov

APPLICATION NO.	FILING DATE	FIRST NAMED I	NVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO
10/708,301	02/23/2004	Akira Ku	ibira	39.034	2300
29453	7590 11/01/200-	4		EXAMINER	
JUDGE PATENT FIRM RIVIERE SHUKUGAWA 3RD FL.				PAIK, SANG YEOP	
<del>-</del> -	MATSU-CHO			ART UNIT	PAPER NUMBER
	IYA-SHI, HYOGO, 662	662-0035		3742	
JAPAN				DATE MAILED: 11/01/2004	4

Please find below and/or attached an Office communication concerning this application or proceeding.

			1 1 1				
Add to the control of	Application No.	Applicant(s)					
	10/708,301	KUIBIRA ET AL.					
Office Action Summary	Examiner	Art Unit					
	Sang Y Paik	3742					
The MAILING DATE of this communication Period for Reply	appears on the cover sheet with	the correspondence add	iress				
A SHORTENED STATUTORY PERIOD FOR RETHE MAILING DATE OF THIS COMMUNICATIO  - Extensions of time may be available under the provisions of 37 CFR after SIX (6) MONTHS from the mailing date of this communication.  - If the period for reply specified above is less than thirty (30) days, a  - If NO period for reply is specified above, the maximum statutory per  - Failure to reply within the set or extended period for reply will, by state Any reply received by the Office later than three months after the material patent term adjustment. See 37 CFR 1.704(b).	N. R 1.136(a). In no event, however, may a replication of the statutory minimum of thirty (3 riod will apply and will expire SIX (6) MONTH atute, cause the application to become ABAN	y be timely filed  30) days will be considered timely. IS from the mailing date of this con IDONED (35 U.S.C. § 133).					
Status							
1) Responsive to communication(s) filed on							
2a) This action is <b>FINAL</b> . 2b) ⊠ T	his action is non-final.						
3) Since this application is in condition for allow	Since this application is in condition for allowance except for formal matters, prosecution as to the ments is						
closed in accordance with the practice unde	er <i>Ex parte Quayl</i> e, 1935 C.D. 1	11, 453 O.G. 213.					
Disposition of Claims							
4) Claim(s) 1-14 is/are pending in the application	ion.						
4a) Of the above claim(s) is/are without	drawn from consideration.						
5) Claim(s) is/are allowed.							
6)⊠ Claim(s) <u>1-14</u> is/are rejected.							
7) Claim(s) is/are objected to.							
8) Claim(s) are subject to restriction and	d/or election requirement.						
Application Papers							
9) The specification is objected to by the Exam	iner.						
10) The drawing(s) filed on is/are: a) □ a	accepted or b) objected to by	the Examiner.	·				
Applicant may not request that any objection to t	he drawing(s) be held in abeyance	. See 37 CFR 1.85(a).					
Replacement drawing sheet(s) including the corr	rection is required if the drawing(s)	is objected to. See 37 CFI	R 1.121(d).				
11) The oath or declaration is objected to by the	Examiner. Note the attached C	Office Action or form PTC	O-152.				
Priority under 35 U.S.C. § 119							
12) Acknowledgment is made of a claim for fore	ign priority under 35 U.S.C. § 1	19(a)-(d) or (f).					
a)⊠ All b)□ Some * c)□ None of:		.,,,,,					
1. Certified copies of the priority docume	ents have been received.						
2. Certified copies of the priority docume	ents have been received in App	lication No					
3. Copies of the certified copies of the p	riority documents have been re	ceived in this National S	Stage				
application from the International Bure	eau (PCT Rule 17.2(a)).						
* See the attached detailed Office action for a I	list of the certified copies not re	ceived.					
Attachment(s)	🗀 .						
Notice of References Cited (PTO-892)     Notice of Draftsperson's Patent Drawing Review (PTO-948)	4) Interview Sum Paper No(s)/N	nmary (PTO-413) //ail Date					
Information Disclosure Statement(s) (PTO-1449 or PTO/SB/0 Paper No(s)/Mail Date <u>5/12/04</u> .		mal Patent Application (PTO-	152)				

Application/Control Number: 10/708,301

Art Unit: 3742

#### **DETAILED ACTION**

#### **Specification**

1. The disclosure is objected to because of the following informalities: the specification shows the "□m" as the unit length for the surface roughness or warpage, but it is not clear if such means square meter or some other unit length. In light of the known semiconductor industry involving ceramic susceptors, the surface roughness or warpage is usually represented in terms of microns (μm) for such microscopic measurement. For the purposes of examining the symbol "pm" is interpreted as microns. However, the applicant needs to amend the specification to clearly define such unit length.

Appropriate correction is required.

### Claim Rejections - 35 USC § 102

2. The following is a quotation of the appropriate paragraphs of 35 U.S.C. 102 that form the basis for the rejections under this section made in this Office action:

A person shall be entitled to a patent unless -

- (b) the invention was patented or described in a printed publication in this or a foreign country or in public use or on sale in this country, more than one year prior to the date of application for patent in the United States.
- 3. Claims 1- 8, 10, 13 and 14 are rejected under 35 U.S.C. 102(b) as being anticipated by Kholodenko et al (US 6,310,755).

Kholodenko et al shows a holder having a ceramic susceptor having a retaining side with a resistive heating element incorporated and positioned in the susceptor toward the side opposite the retaining side, and a metal plate provided on the susceptor opposite the retaining side.

Kholodenko et al further shows that the ceramic susceptor which is made of one of alumina, aluminum nitride, silica, silicon carbide, silicon nitride or boron carbide is bonded to the metal

plate which is made of metal with the combination aluminum, silicon carbide, copper, tungsten and/or molybdenum.

With respect to claims 5 and 7, the claimed thermal conductivity is also inherently anticipated by Kholodenko et al since it shows that the ceramic susceptor and the metal plate are made of the same material or composition as claimed.

With respect to claim 10, Kholodenko et al further shows that the susceptor has the diameter of about 200mm.

4. Claims 1-3, 5-9, 13 and 14 are rejected under 35 U.S.C. 102(b) as being anticipated by Kadomura et al (US 5,968,273).

Kadomura et al shows a holder having a ceramic susceptor having a retaining side with a resistive heating element incorporated and position in the susceptor toward the side opposite the retaining side, the metal plate, which is made of aluminum and silicon carbide, having a thickness thicker than the ceramic susceptor bonded to the ceramic susceptor on the opposite side of the retaining side, and the ceramic substrate made of aluminum nitride.

With respect to claims 5 and 7, the claimed thermal conductivity is also inherently anticipated by Kadomura et al since it shows that the ceramic susceptor and the metal plate are made of the same material or composition as claimed.

## Claim Rejections - 35 USC § 103

- The following is a quotation of 35 U.S.C. 103(a) which forms the basis for all 5. obviousness rejections set forth in this Office action:
  - (a) A patent may not be obtained though the invention is not identically disclosed or described as set forth in section 102 of this title, if the differences between the subject matter sought to be patented and the prior art are such that the subject matter as a whole would have been obvious at the time the invention was made to a person having ordinary skill in the art to which said subject matter pertains. Patentability shall not be negatived by the manner in which the invention was made.

Application/Control Number: 10/708,301

Art Unit: 3742

6. Claim 11 is rejected under 35 U.S.C. 103(a) as being unpatentable over Kholodenko et al (US 6,310,755) or Kadomura et al (US 5,968,273) in view of Hiramatsu et al (US 6,507,006).

Kholodenko et al or Kadomura et al shows the holder claimed except the claimed porosity.

Hiramatsu shows a semiconductor wafer chuck with a ceramic substrate with the porosity less than 5%, and, preferably from 0.01 to 3%. In view of Hiramatsu, it would have been obvious to one of ordinary skill in the art to adapt Kholodenko et al or Kadomura et al with the claimed porosity to more effectively maintain the voltage drop in the ceramic substrate to improve the chucking of a wafer to the heating surface.

7. Claim 12 is rejected under 35 U.S.C. 103(a) as being unpatentable over Kholodenko et al (US 6,310,755) or Kadomura et al (US 5,968,273) in view of Ito et al (US 6,717,116).

Kholodenko et al or Kadomura et al shows the holder claimed except the claimed warpage.

Ito et al shows a semiconductor wafer heater having a surface flatness or warpage of less than 50 microns. In view of Ito et al, it would have been obvious to one of ordinary skill in the art to adapt Kholodenko et al or Kadomura et al with the retaining side with the claimed warpage to ensure a uniform heating transfer between the heating surface and a heated object.

8. Any inquiry concerning this communication or earlier communications from the examiner should be directed to Sang Y Paik whose telephone number is 703-308-1147. The examiner can normally be reached on M-F (9:00-4:00) First Friday Off.

Application/Control Number: 10/708,301

Art Unit: 3742

Page 5

The fax phone number for the organization where this application or proceeding is assigned is 703-872-9306.

Information regarding the status of an application may be obtained from the Patent Application Information Retrieval (PAIR) system. Status information for published applications may be obtained from either Private PAIR or Public PAIR. Status information for unpublished applications is available through Private PAIR only. For more information about the PAIR system, see http://pair-direct.uspto.gov. Should you have questions on access to the Private PAIR system, contact the Electronic Business Center (EBC) at 866-217-9197 (toll-free).

s.Pc

Sang Y Paik Primary Examiner Art Unit 3742

syp